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SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK1549-R

SPEC. No. :

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED
DRAWN			
CHECKED			

Fuji Electric Co.,Ltd.

DWG.NO.

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1. Scope
This specifies Fuji power MOSFET 2SK1549-R

2. Construction N-channel enhancement mode power MOSFET

3. Application for switching

4. Outview TO-3PF Outview See to 4/10 page

5. Absolute maximum ratings at Tc=25℃ (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-source voltage	V_{DS}	250	V	
Drain-gate voltage	V_{DGR}	250	V	R_{GS}=20KΩ
Continuous Drain current	I_D	± 20	A	
Pulsed drain current	I_{Dpulse}	± 80	A	
Gate-source voltage	V_{GS}	± 20	V	
Maximum power dissipation	P_D	80	W	
Operating and storage temperature range	T_{ch}	150	℃	
	T_{stg}	-55 ～ +150	℃	

6. Electrical characteristics at Tc=25℃ (unless otherwise specified)
Static ratings

Description	Symbol	Conditions		Characteristics			Unit
				Min.	Typ.	Max.	
Drain-source breakdown voltage	BV_{DSS}	I_D=1mA V_{GS}=0V		250			V
Gate threshold voltage	$V_{GS(th)}$	I_D=10mA $V_{DS}=V_{GS}$		2.1	3.0	4.0	V
Zero gate voltage drain current	I_{DSS}	V_{DS}=250V V_{GS}= 0V	T_{ch}= 25℃		10	500	μA
	I_{DSS}		T_{ch}=125℃		0.2	1.0	mA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm$20V V_{DS}= 0V			10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	I_D=10 A V_{GS}=10 V			0.11	0.15	Ω

Dynamic ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	gfs	I_D =10 A V_{DS}=25 V	8.0	15.0		S
Input capacitance	Ciss	V_{DS}=25V V_{GS}= 0V f =1MHz		2000	3000	pF
Output capacitance	Coss			350	500	pF
Reverse transfer capacitance	Crss			110	200	pF
Turn-on time	td(on)	V_{CC}= 30V V_{GS}= 10V I_D = 3A R_{GS}= 50Ω		30	50	ns
	tr			70	110	ns
Turn-off time	td(off)			400	600	ns
	tf			120	180	ns

Reverse diode

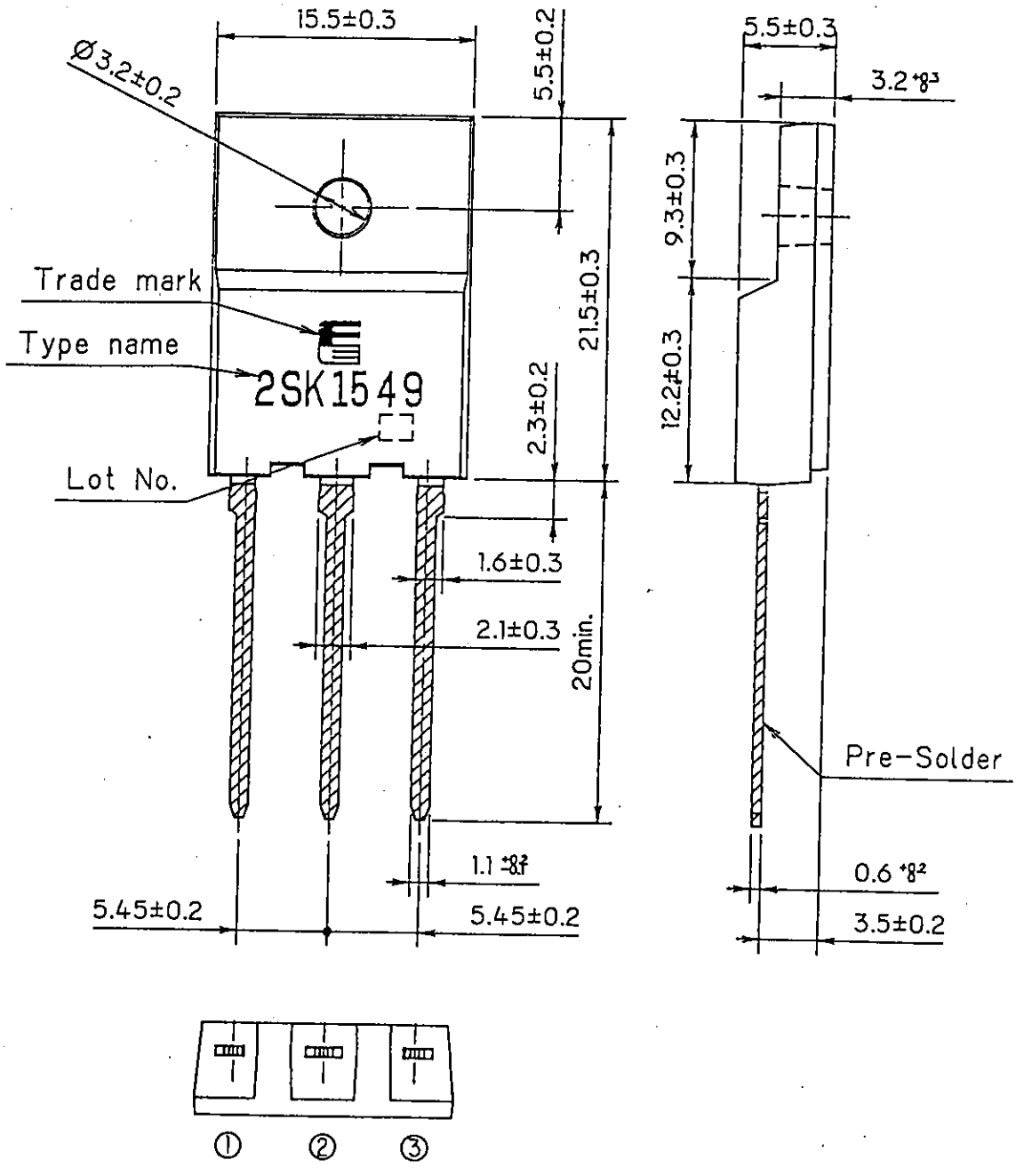
Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Diode forward on-voltage	V_{SD}	I_F = 2 × I_{DR} V_{GS}=0V, T_{ch}=25℃		1.0	1.7	V
Reverse recovery time	t_{rr}	I_F = I_{DR} V_{GS}=0V $-dI_F/dt$=100A/μs T_{ch}=25℃		250		ns
Reverse recovery charge	Q_{rr}			2		μC

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	Rth_{ch}-c				1.56	℃/W
	Rth_{ch}-a				30.0	℃/W

FUJI POWER MOSFET

TYPE : 2SK1549-R

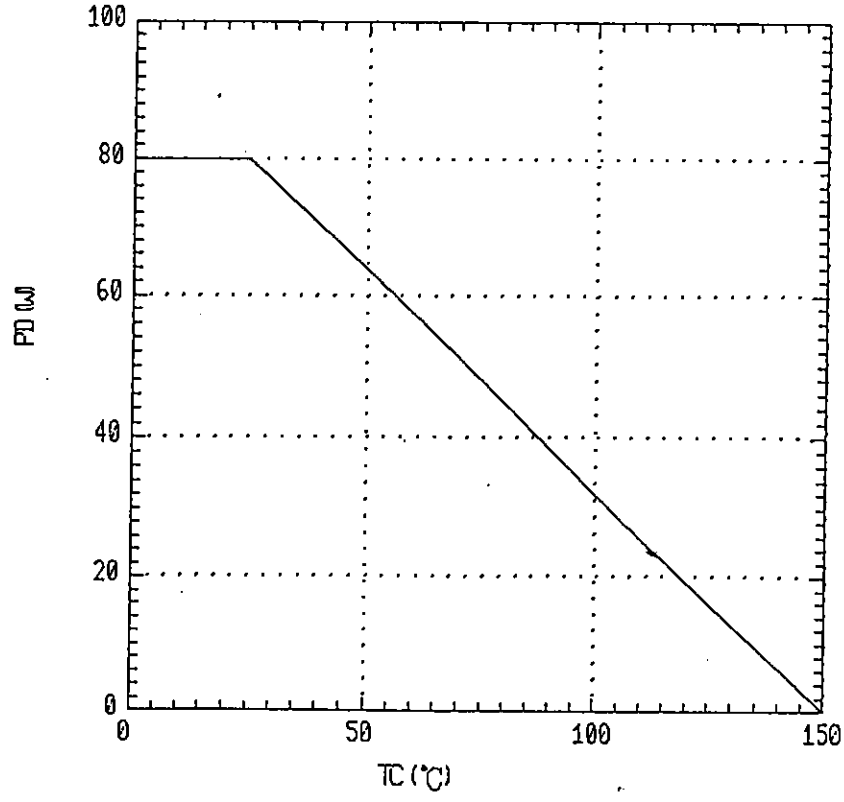


CONNECTION

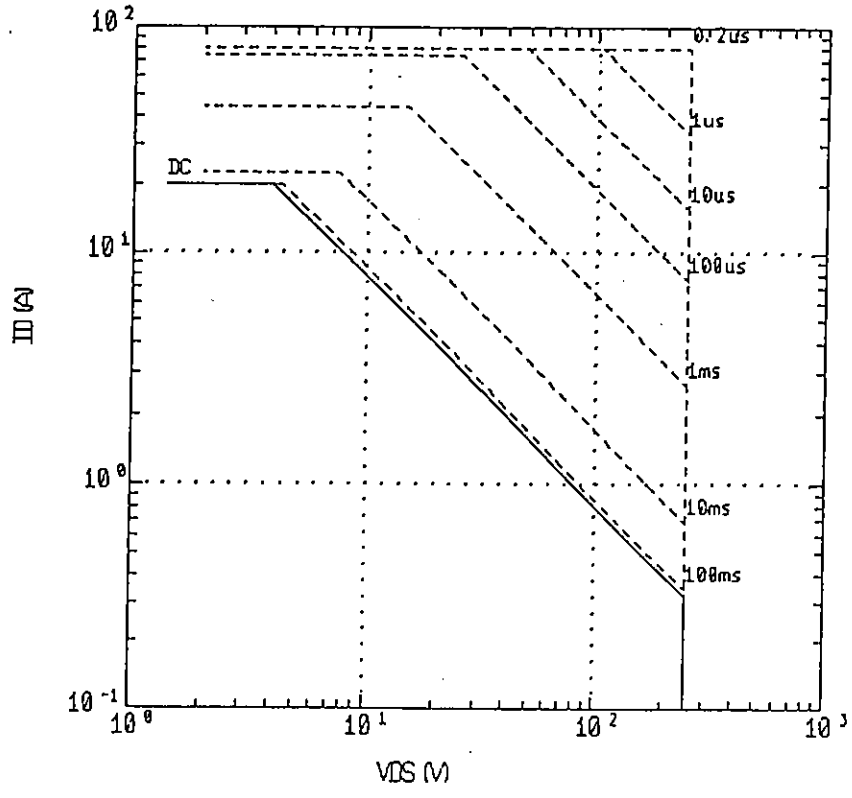
① GATE
② DRAIN
③ SOURCE

DIMENSIONS ARE IN MILLIMETERS.

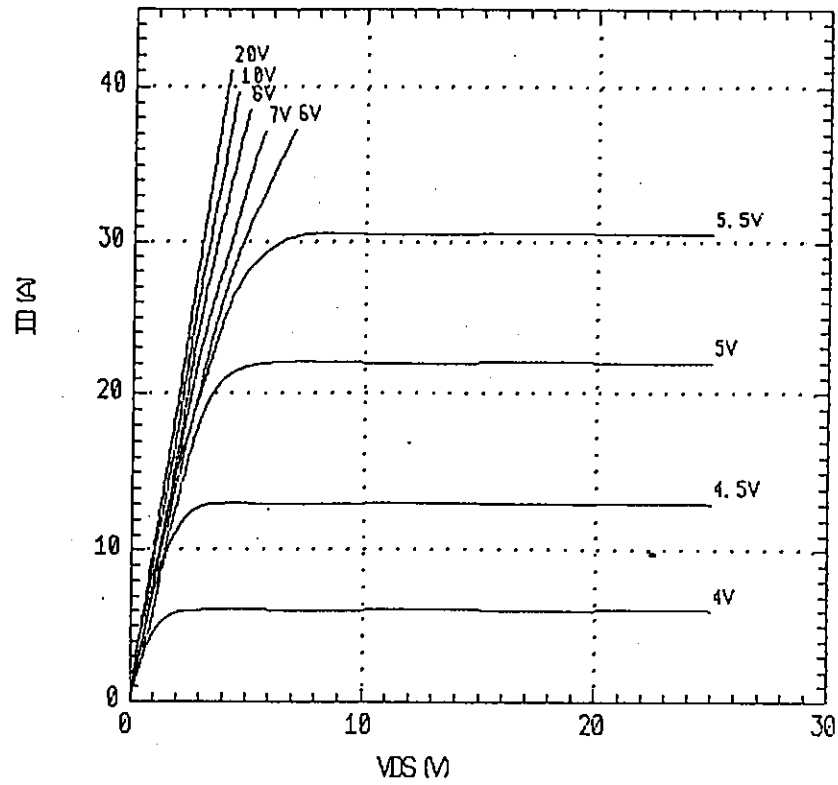
Power Dissipation
PD=f(TC)



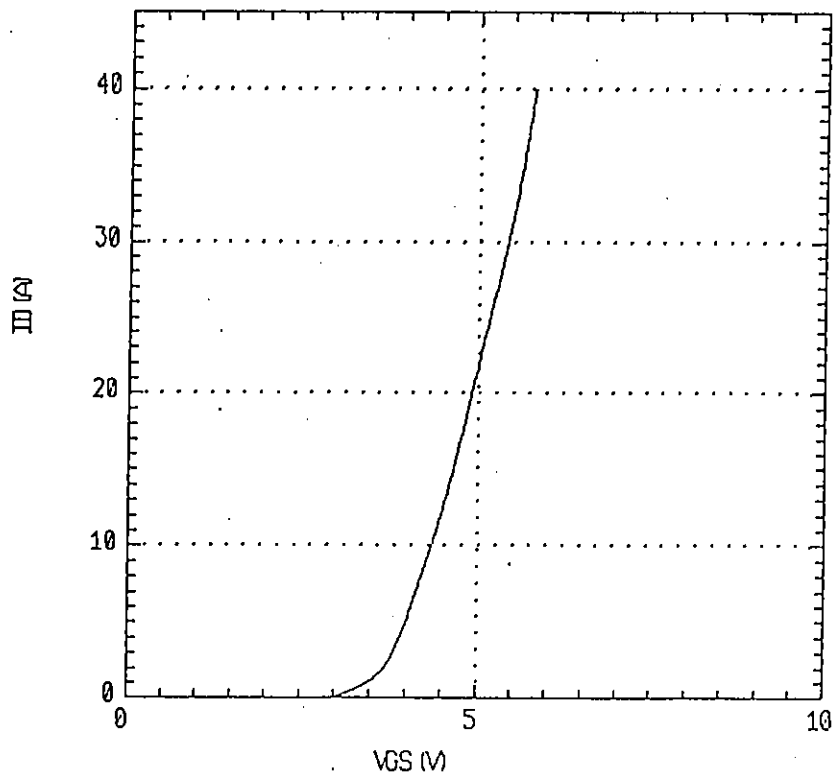
Safe operating area
ID=f(VDS):D=0.01,Tc=25°C



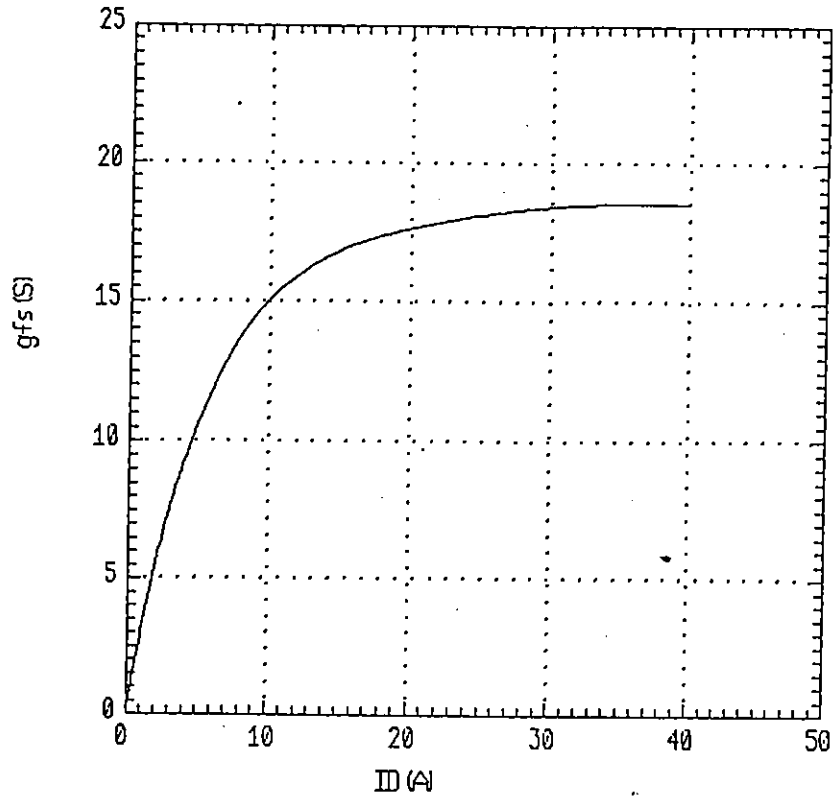
Typical output characteristics
ID=f(VDS):80μs pulse test,Tch=25°C



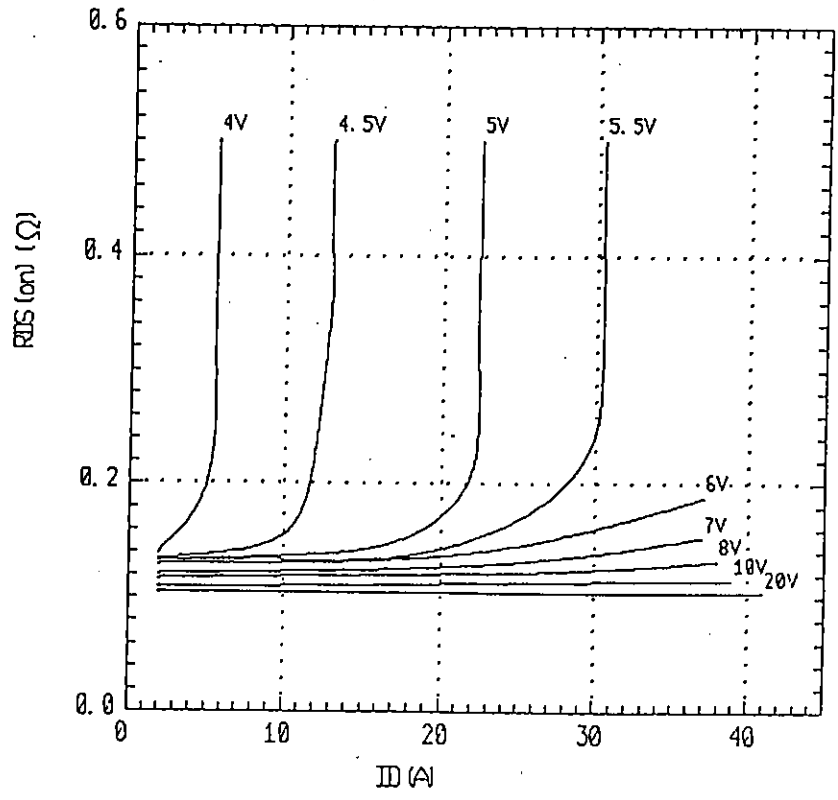
Typical Transfer Characterisic.
ID=f(VGS):80μs pulse test,VDS=25V,Tch=25°C



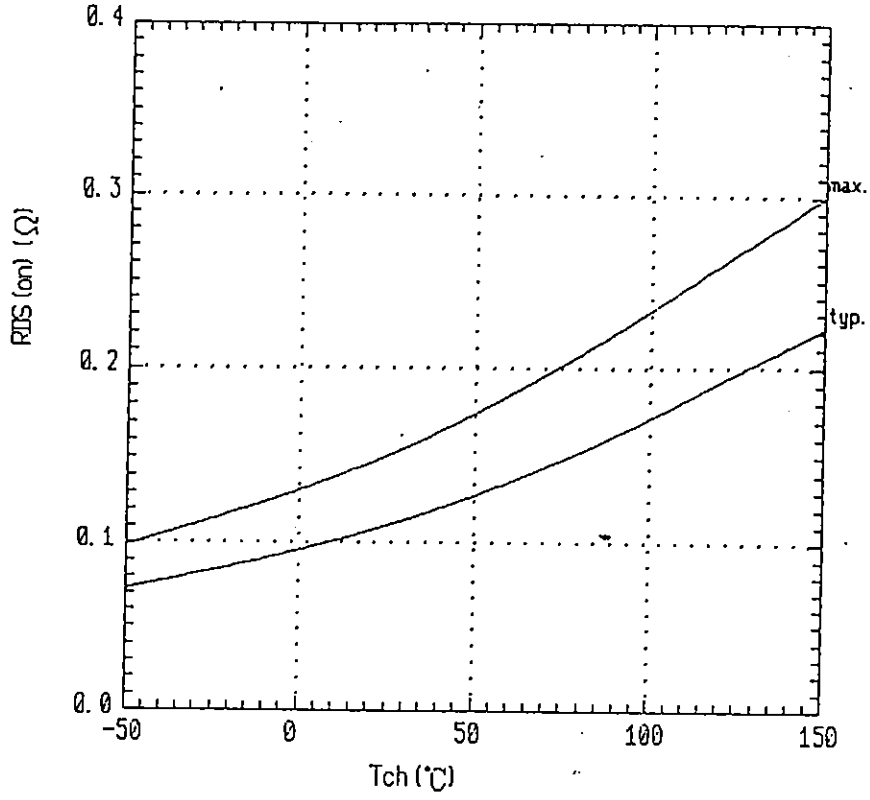
Typical Transconductance
gfs=f(ID):80μs pulse test,VDS=25V,Tch=25℃



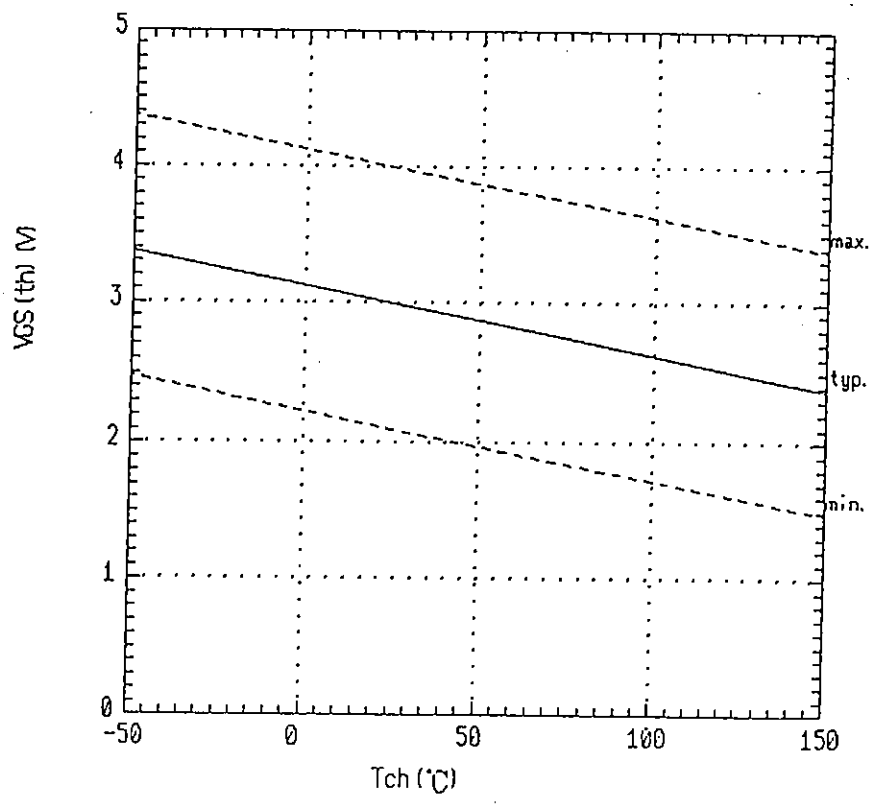
Typical Drain-source on-state resistance
RDS(on)=f(ID):80μs pulse test,Tch=25℃



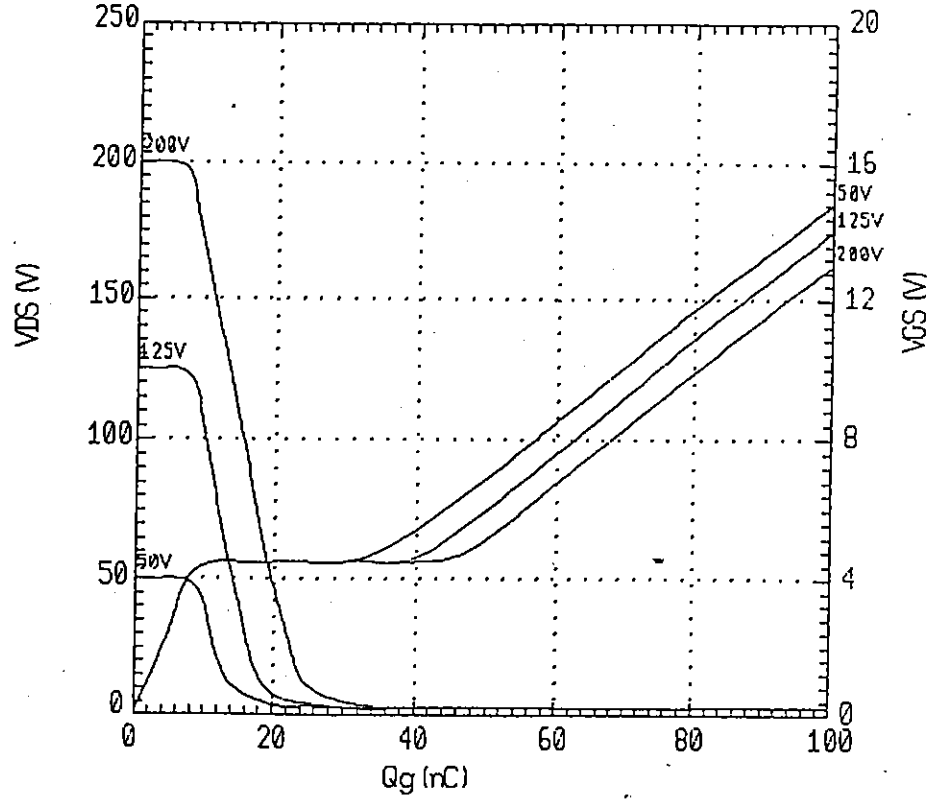
Drain-source on-state resistanse
RDS(on)=f(Tch):ID=10A,VGS=10V



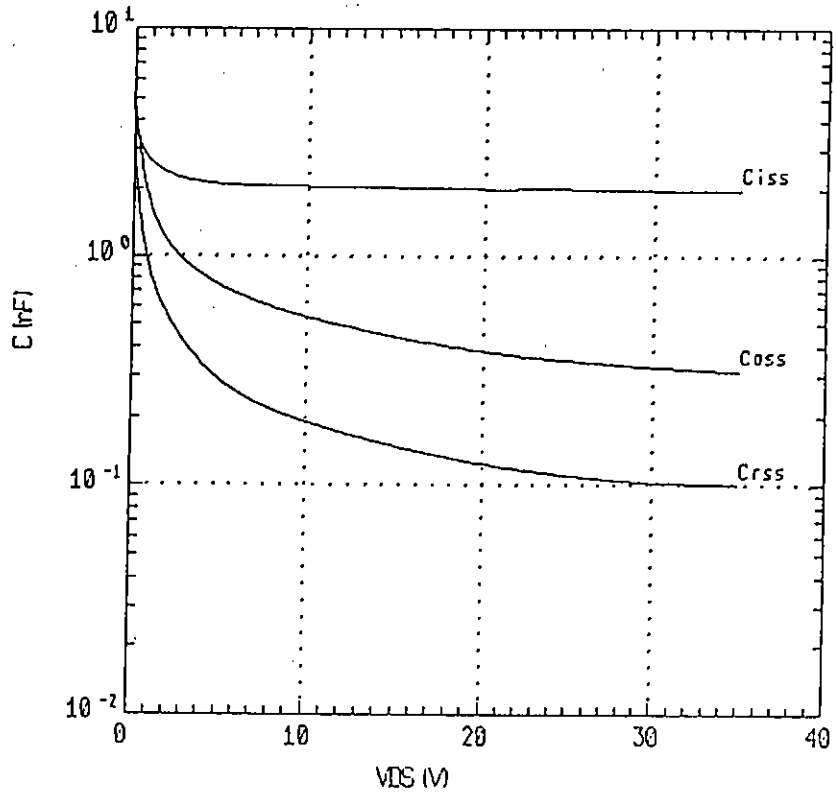
Gate threshold voltage
VGS(th)=f(Tch):VDS=VGS,ID=10mA



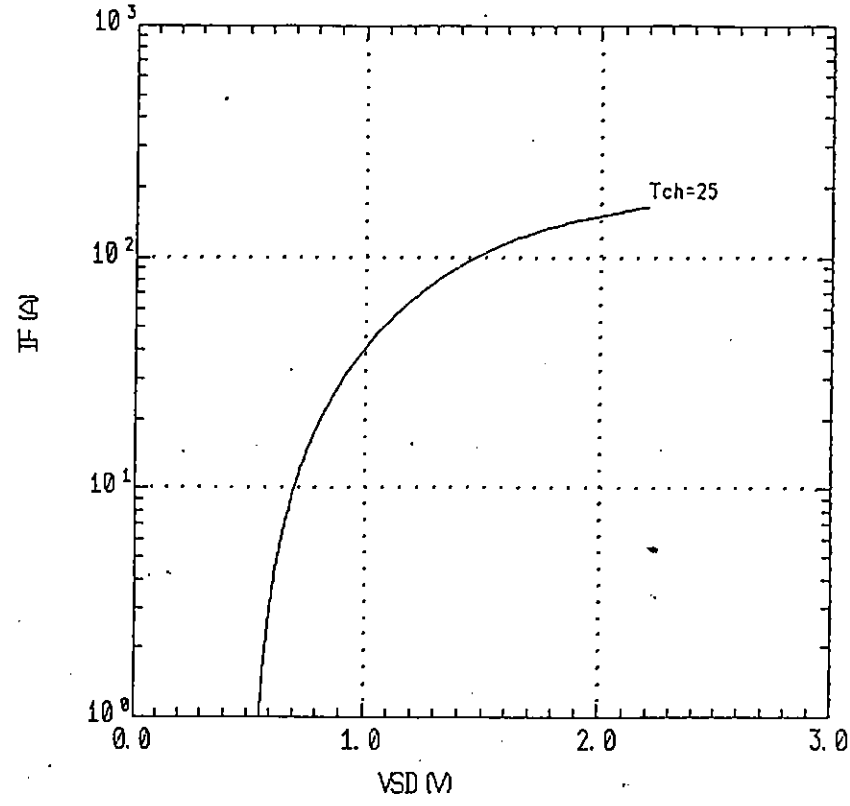
Typical gate charge characteristics
VGS=f(Qg):ID=20A,Tch=25°C



Typical capacitances
C=f(VDS):VGS=0V,f=1MHz



Farward characteristic of revese diode
IF=f(VSD):80μs pulse test,VGS=0V



Transient thermal
impedance Zthch-c=f(t) parameter:D=t/T